

## Fea In XE Detector

Romain Gaïor on behalf of the D\_RD\_34 project

# Scientific context

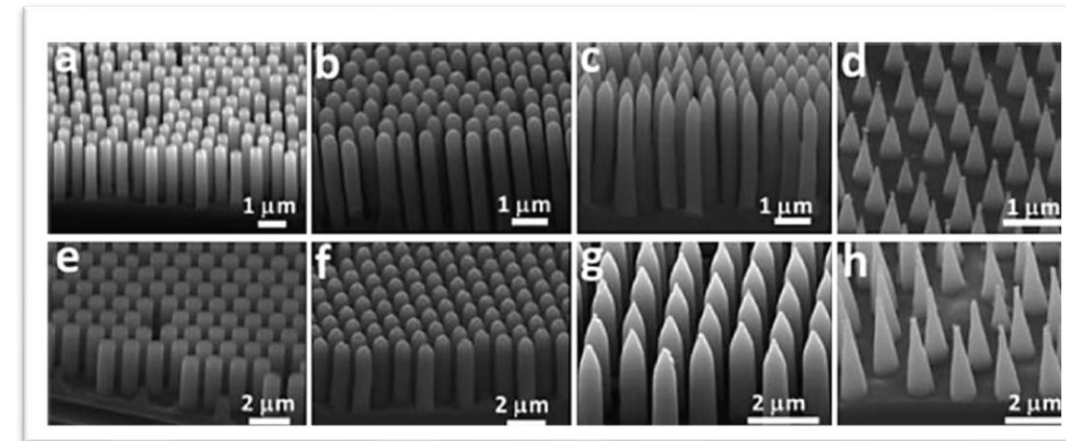
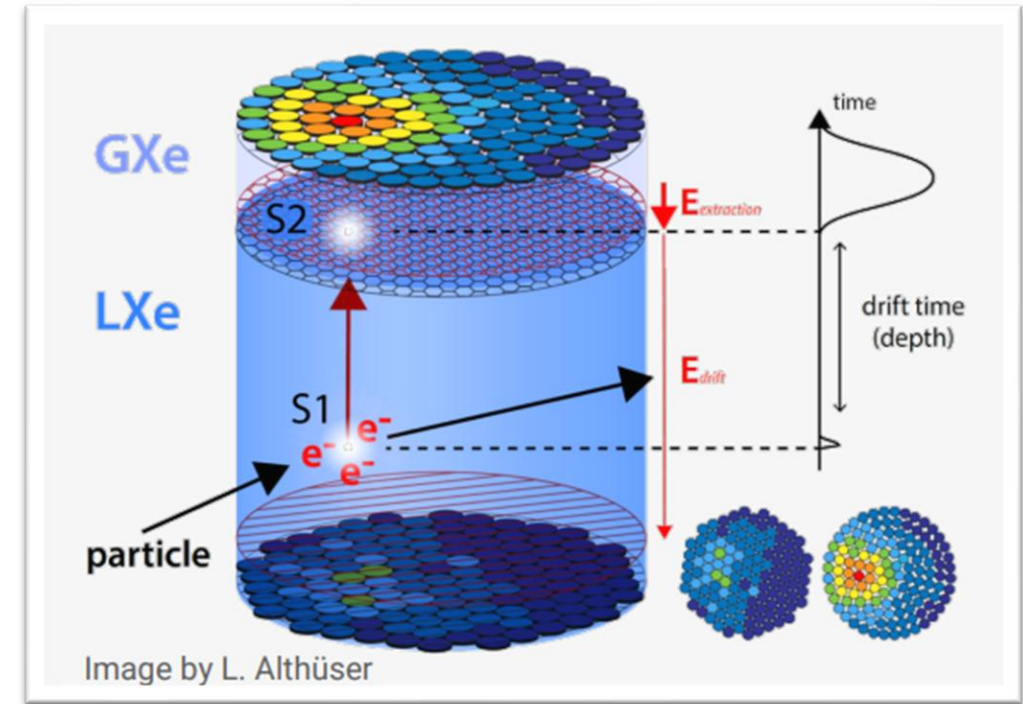
Next generation LXe Experiment (XLZD):  
50-100 tons, few meter scale for rare event searches (Dark Matter, neutrinos,  $0\nu\text{BB}$ )

## (some)Problematics with large detectors

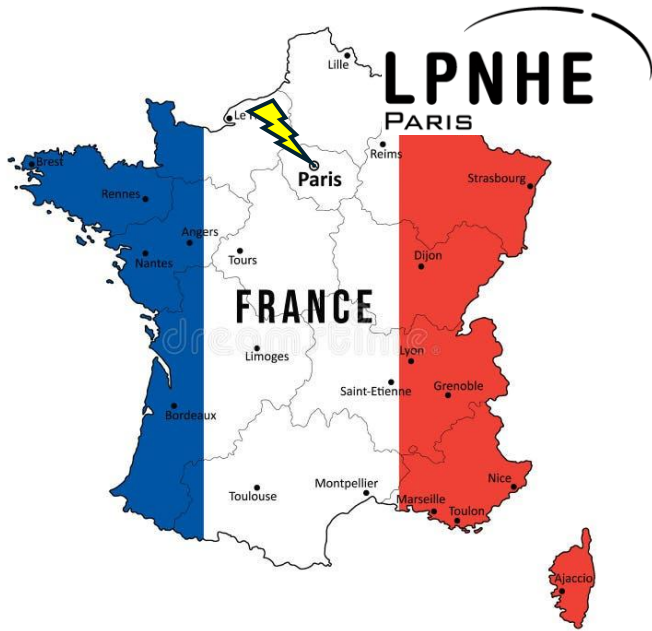
- Radioactive purity: need for faster purification methods (Radon)
- Electrodes for secondary scintillation:  
Mechanical issues, resolution, spurious charge

## FEA: Microscopic Conductive structure

- Large electric field site
- Various shape / material (Cu, Si) / fabrication method
- Used in industry in vacuum



# FIXED (D\_RD\_34) around the world



## LPNHE

- Romain GAIOR (now at ILANCE)
- Luca SCOTTO LAVINA
- Yajing XING
- Veronica CAZZOLA



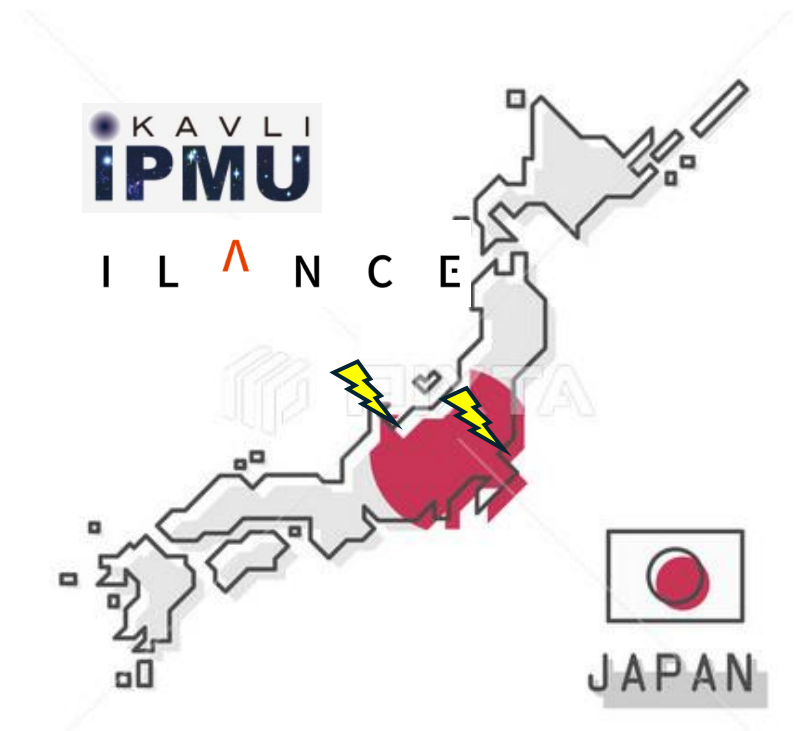
## Munster

- Christian WEINHEIMER

## OTH Regensburg

- R. SCHREINER
- M. HAUSLADEN

TYL FJPPN /FKPPN 2026 D\_RD\_34 (R. GAIOR)



## IPMU (Kamioka)

- Kai MARTENS
- Caio ISHIKAWA
- Xiaoxin WANG
- Masaki YAMASHITA  
(now in Nagoya University)

# Liquid Xenon Purification

## Hole emission in LXe

Large E field ( $\sim 10\text{MV/cm}$ ) at the tip to “emit” hole

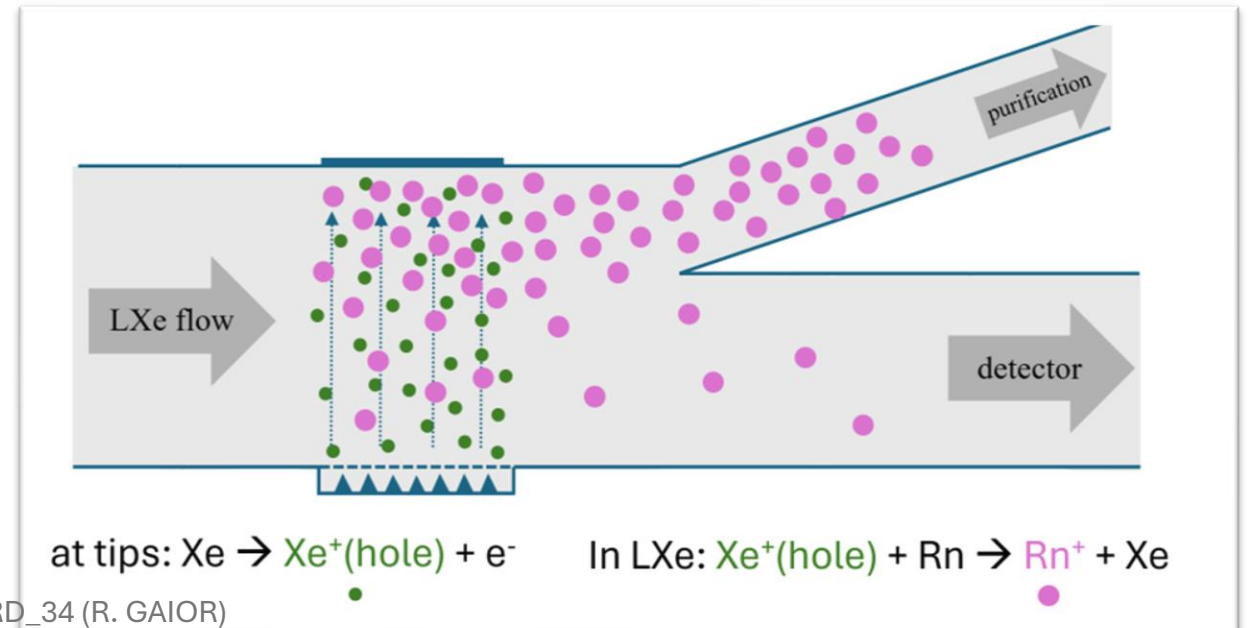
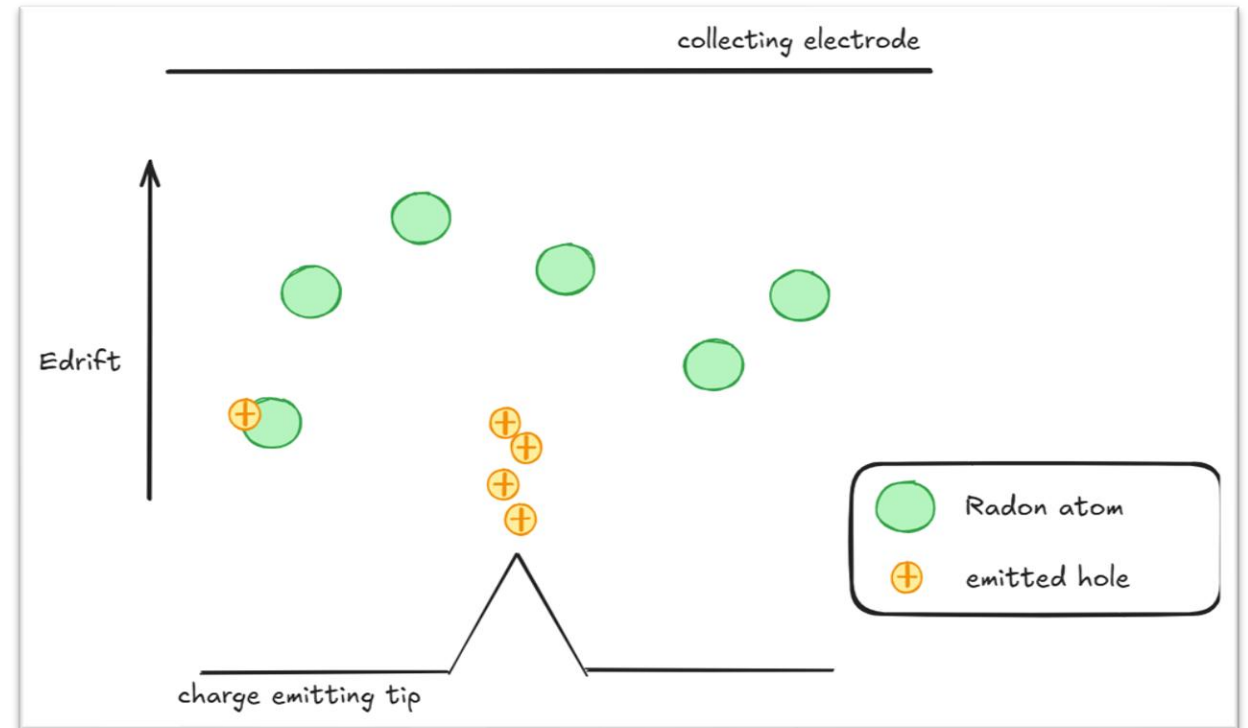
## Hole attachment time to radon ?

Is the attachment time long enough to drift the Rn over sizeable distance

## Stable operation ?

Are we able to operate at very high field ( $\sim \text{GV/m}$ )

Work from Caio and Xiaoxin and Kai @ Kamioka  
Visit of R.G. in Jan 2026



# Kamioka setup

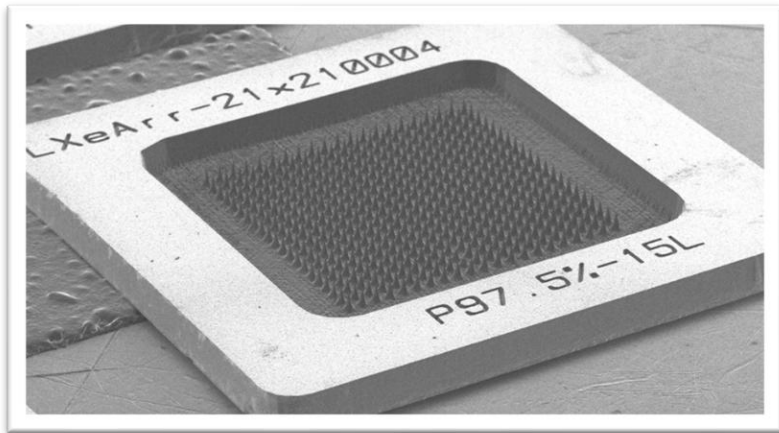
## 21x21 FEA chip (OTH Regensburg)

Previous data taking with 1 tip/chip

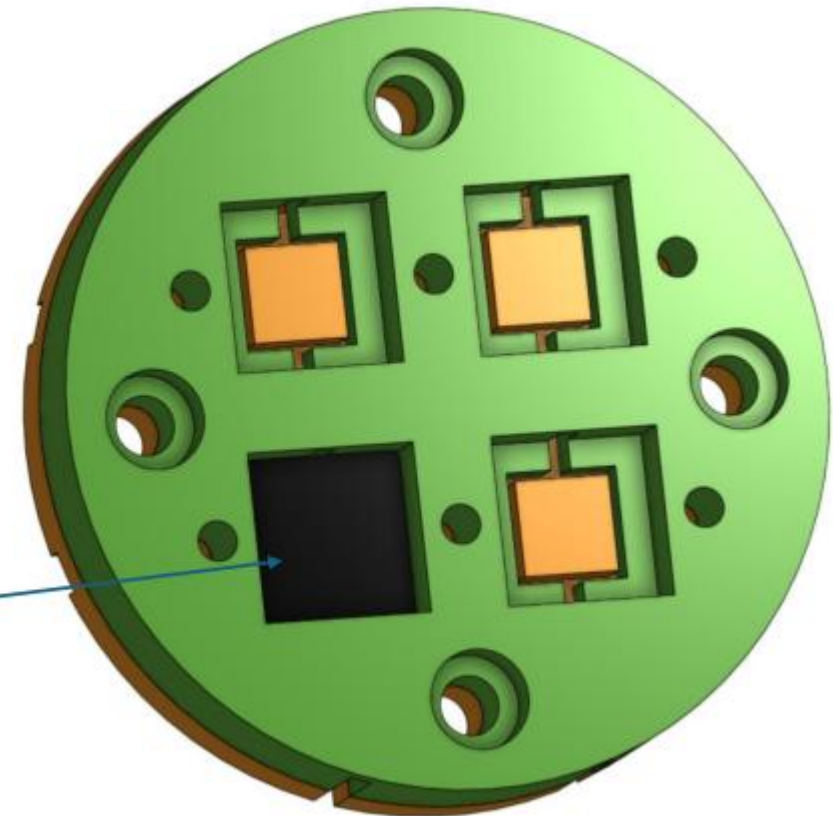
## Improved the insulator

Breakthrough found on previous insulator

## Four chips at the same time

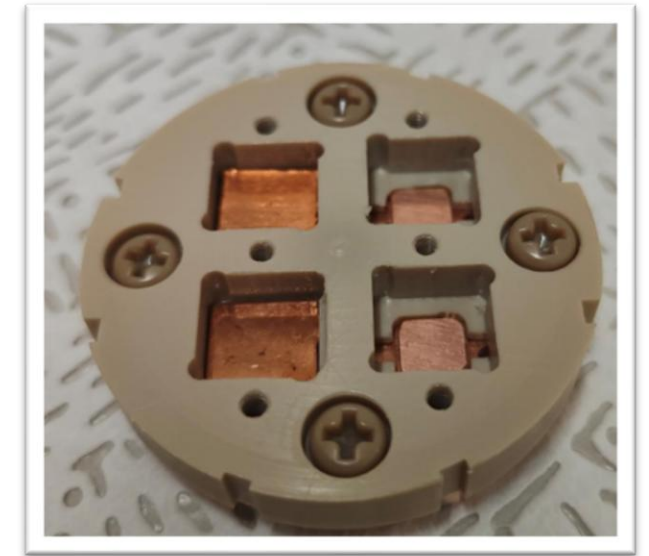
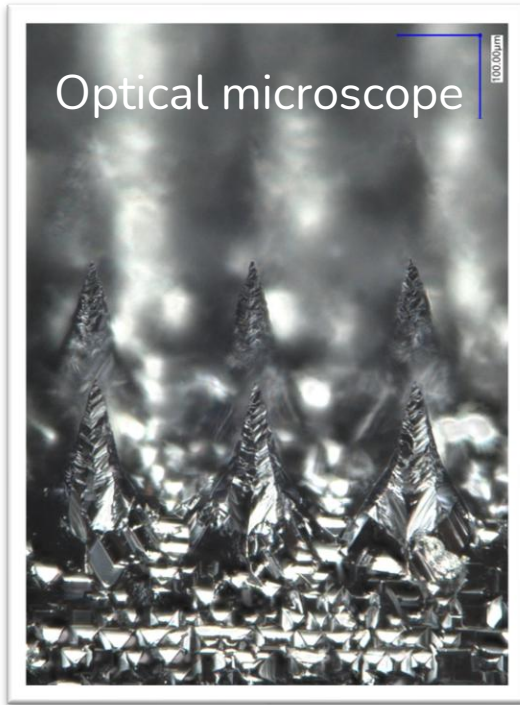


FEA chip 21x21 (doped silicon)



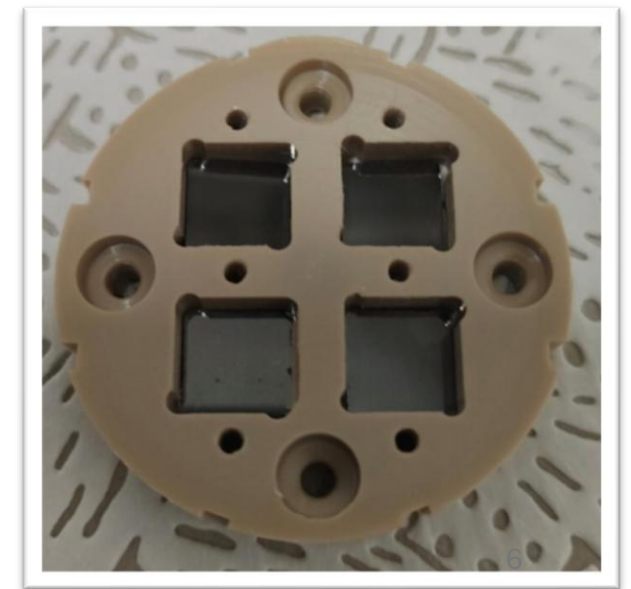
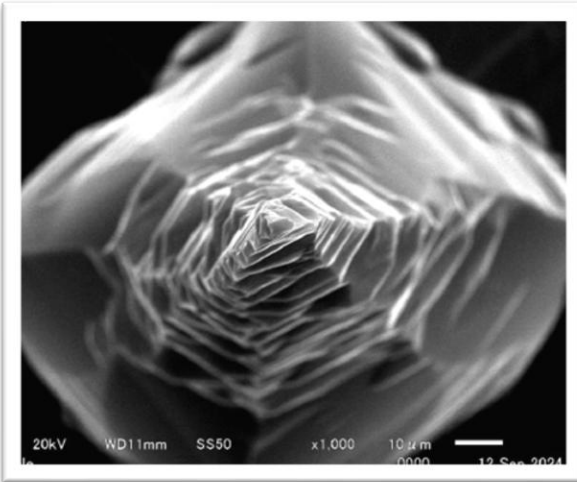
Back of a FEA chip  
In contact with HV

# Kamioka setup

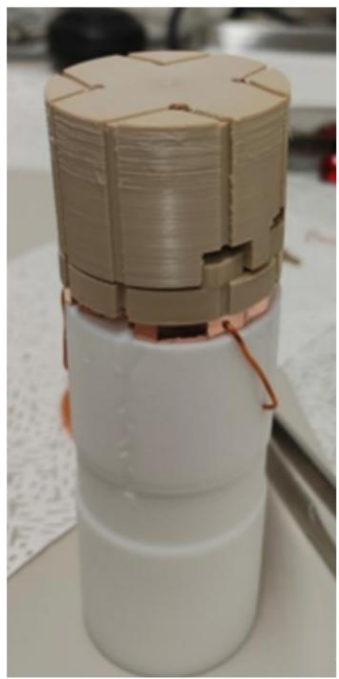


Chips placed in the holder

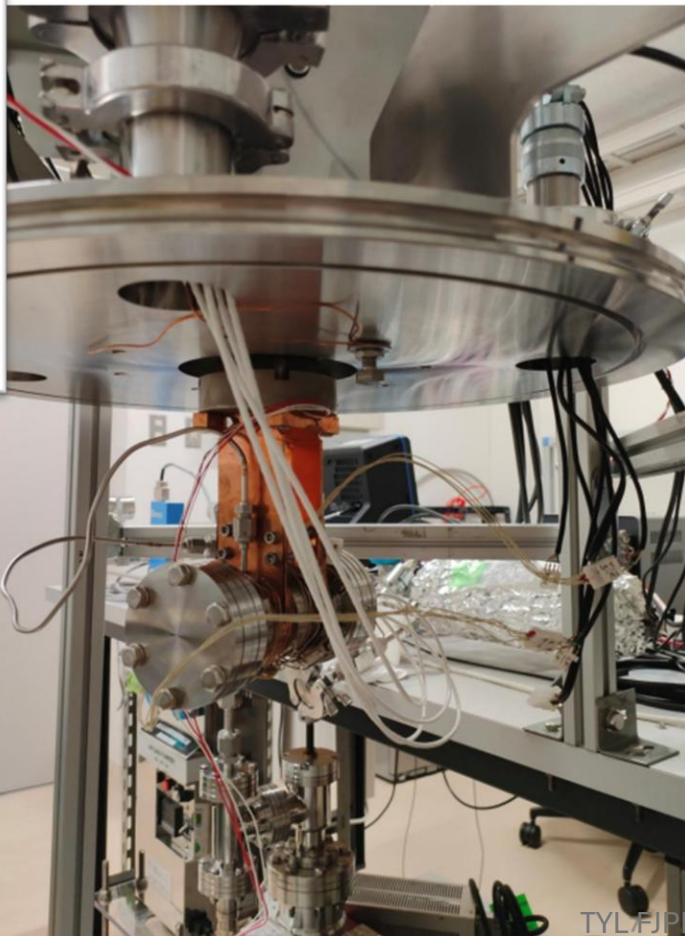
Scanning Electron Microscope



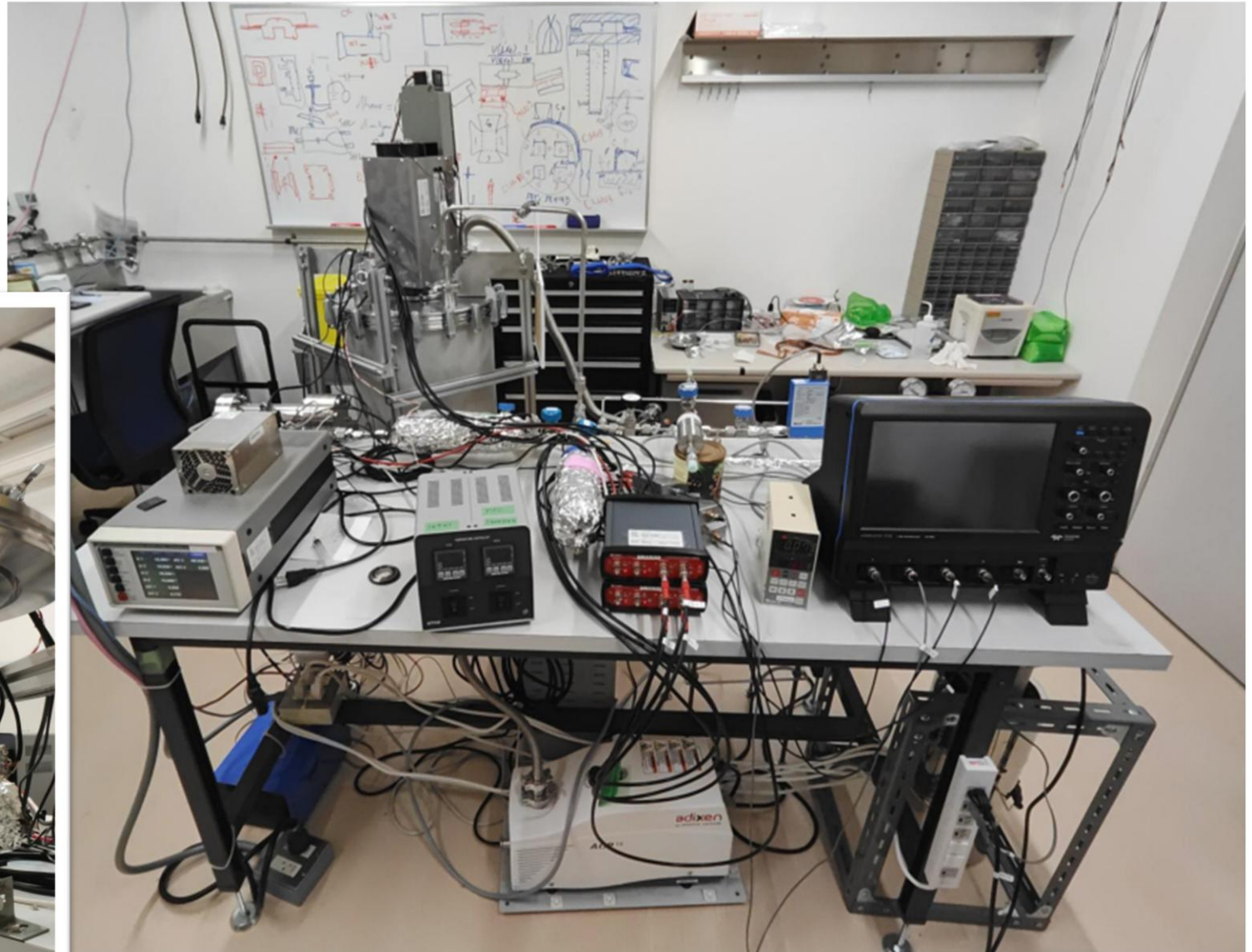
# Kamioka setup



LXe chamber inside a vacuum chamber

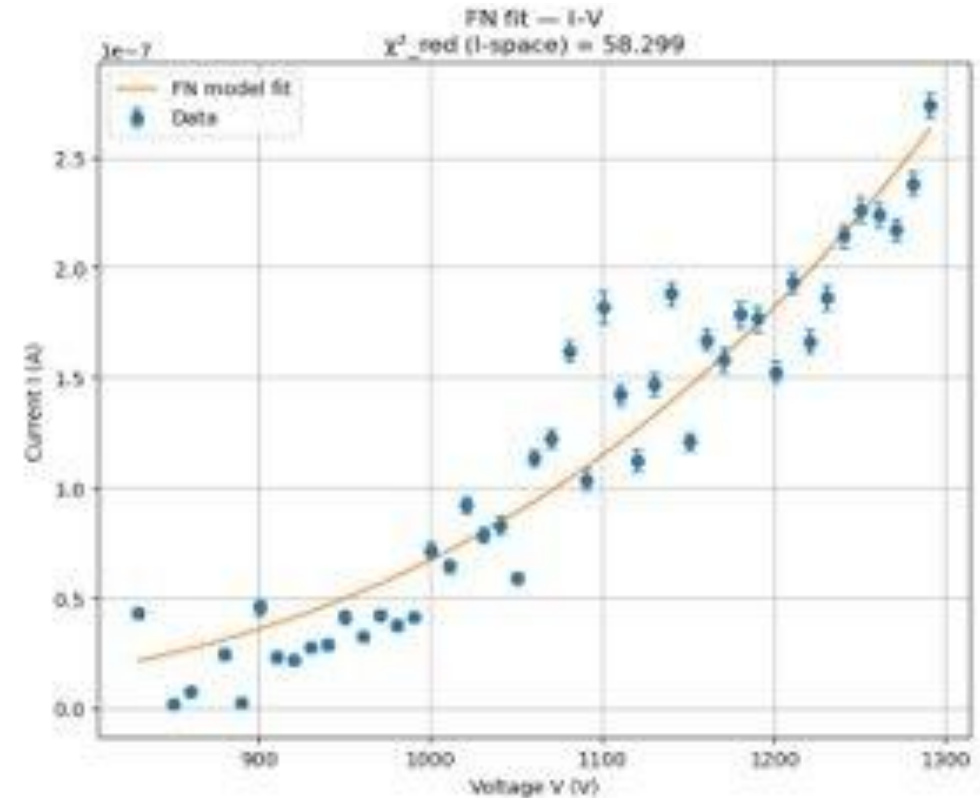
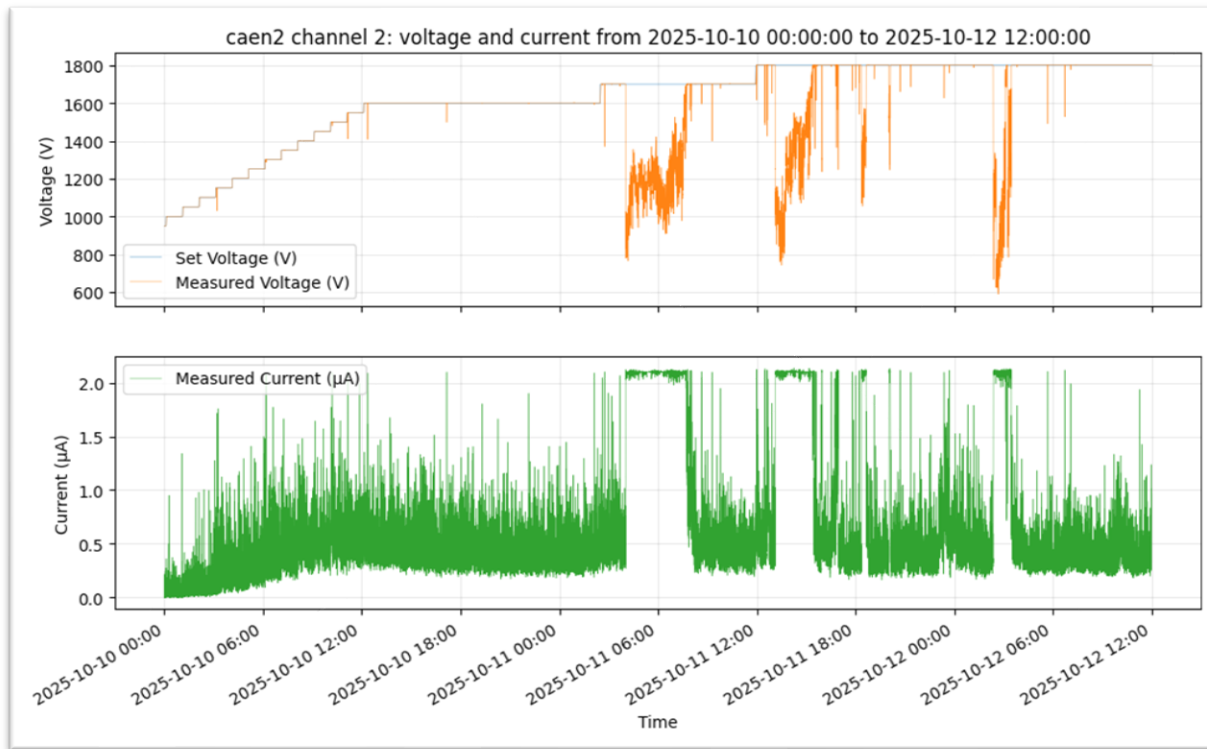


Holder inserted in a filler



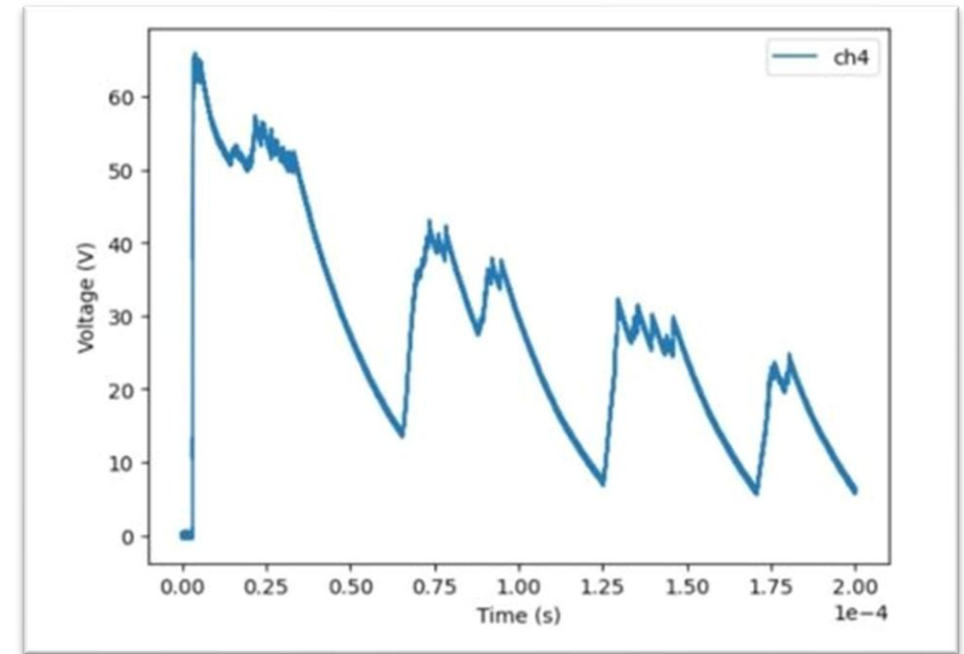
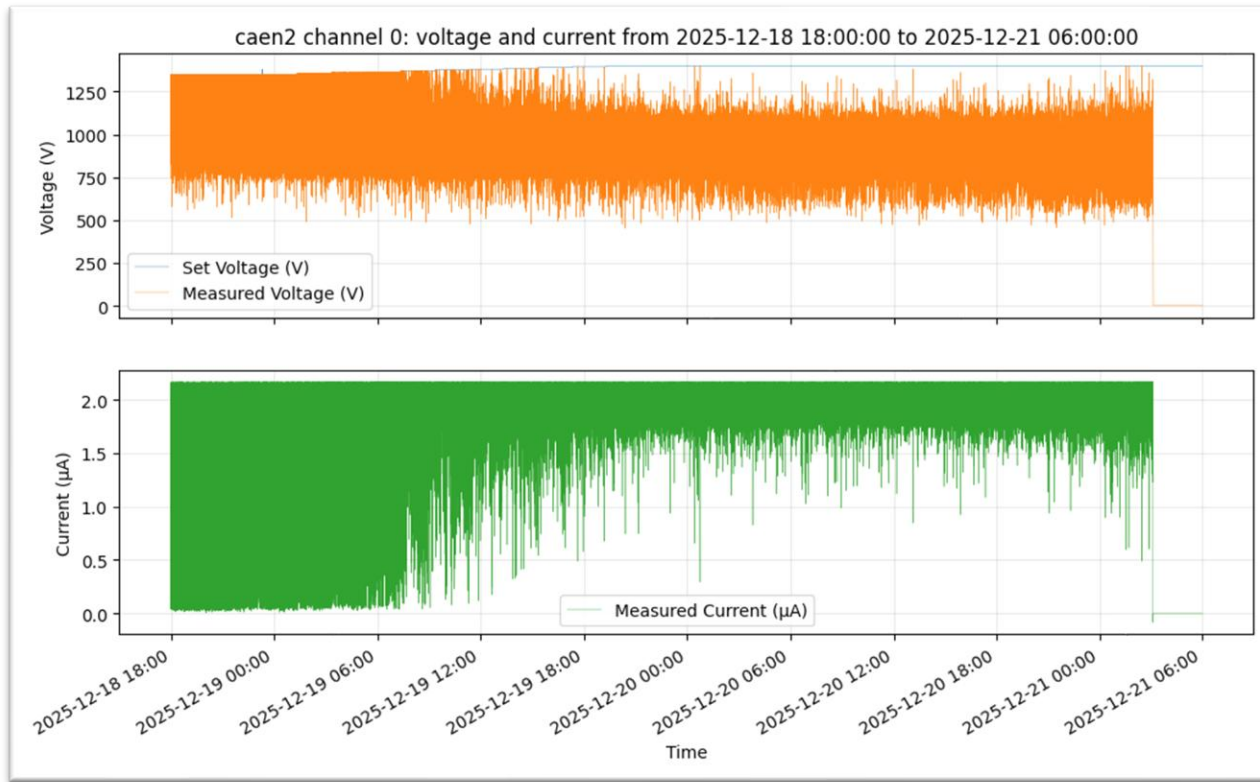
Complete system installed at IPMU lab in Mozumi

# Emission in vacuum



- **Emission in vacuum well controlled**, expected I-V relation
- Allow for the conditioning of the tips
- Average current sometime undergo a sudden change after a spike: possible smoothing of sharpest part of the tip

# Emission in Liquid Xenon



- **Positive and Negative current** in liquid xenon happens in burst/discharge
- Current can be kept constant in average by controlling the frequency of these discharges
- Reproducible behavior
- Will open the chamber and inspect the FEA next month (optical and SEM)

# Secondary scintillation in Liquid Xenon

## Secondary scintillation

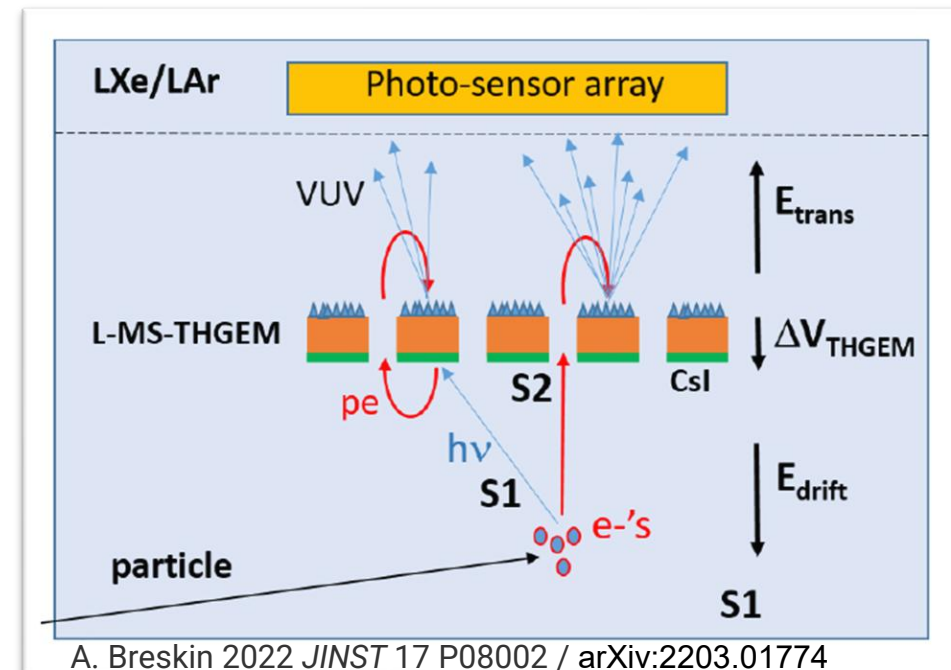
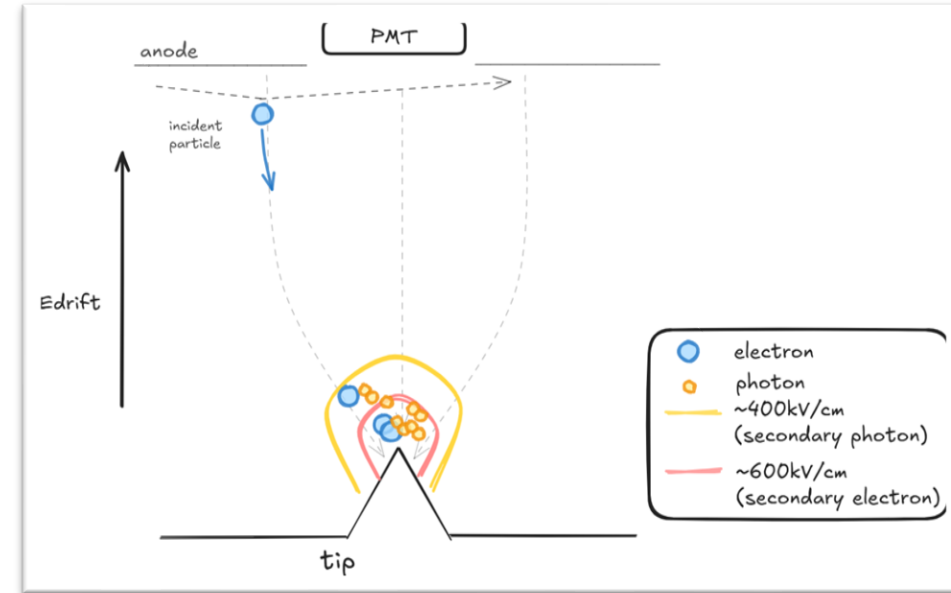
Large E field ( $\sim 1\text{MV/cm}$ ) at the tip to accelerate charges and produce in turn “emit” photon and secondary electrons

## Photon yield

Can we produce enough photon to produce a detectable signal (without too many secondary electrons...)

## Stable operation ?

Are those device stable ? Can we find a suitable geometry for large TPC



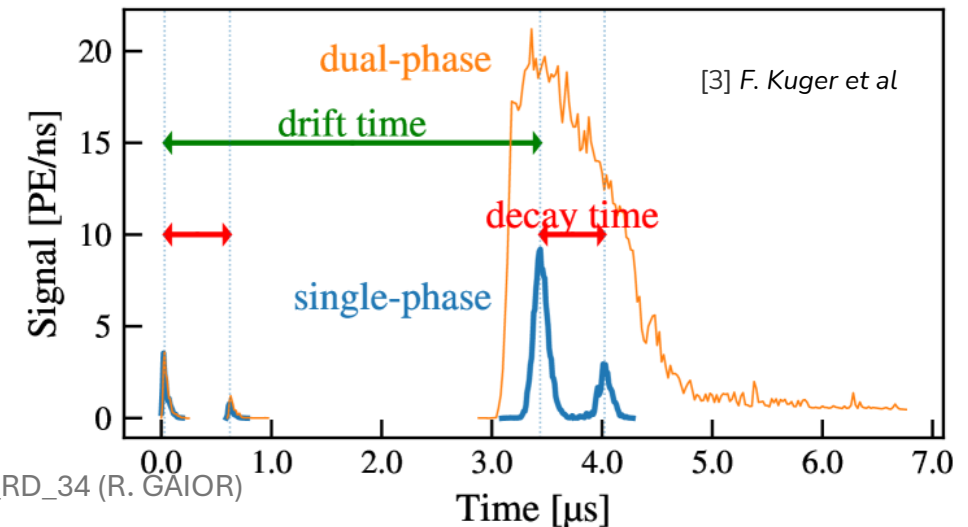
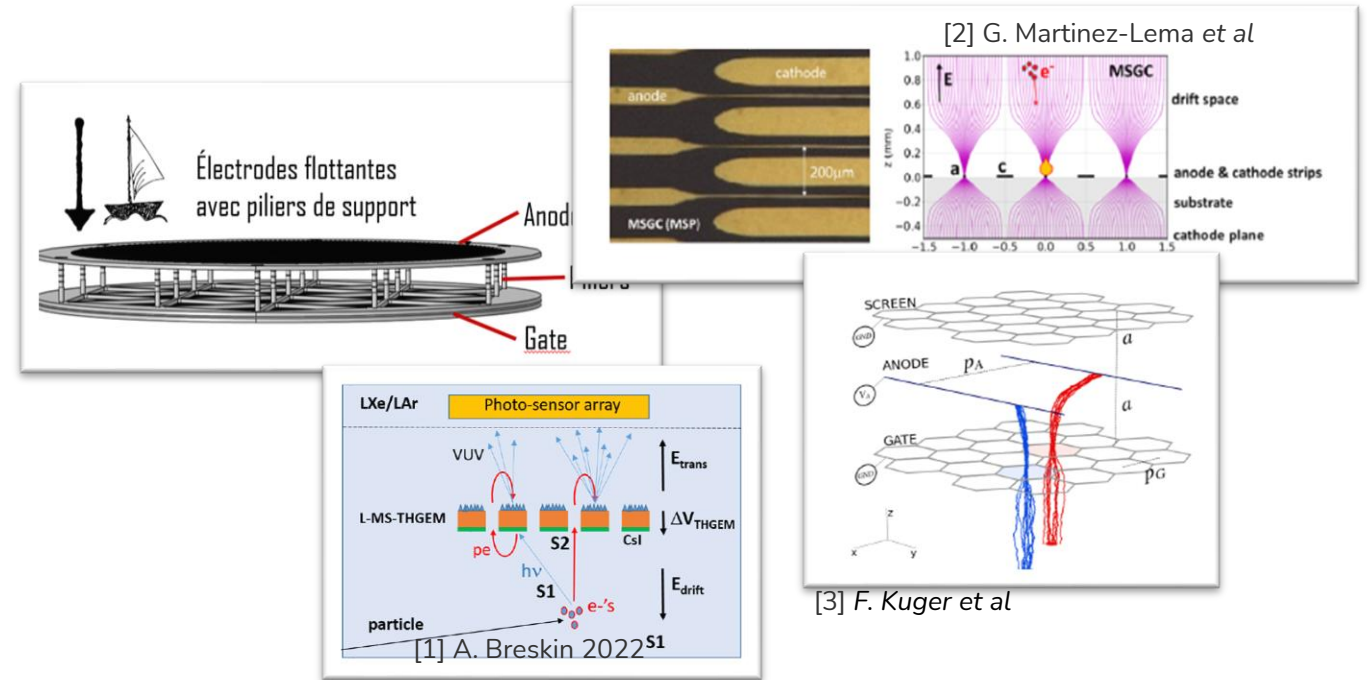
# R&D for electrodes in LXe / GXe

## Several R&D to replace double phase paradigm

## Rational for a one phase (liquid) solution

- ✓ No liquid - gas interface
- ✓ No electrode sagging
- ✓ No delayed electrons
- ✓ Cleaner S2 signal

- Large local electric field
- Not as studied as double phase for rare event searches



[1] A. Breskin 2022 *JINST* 17 P08002 / [arXiv:2203.01774](https://arxiv.org/abs/2203.01774)

[2] G. Martinez-Lema et al 2024 *JINST* 19 P02037

[3] F. Kuger et al 2022 *JINST* 17 P03027 [arXiv:2405.10687](https://arxiv.org/abs/2405.10687)

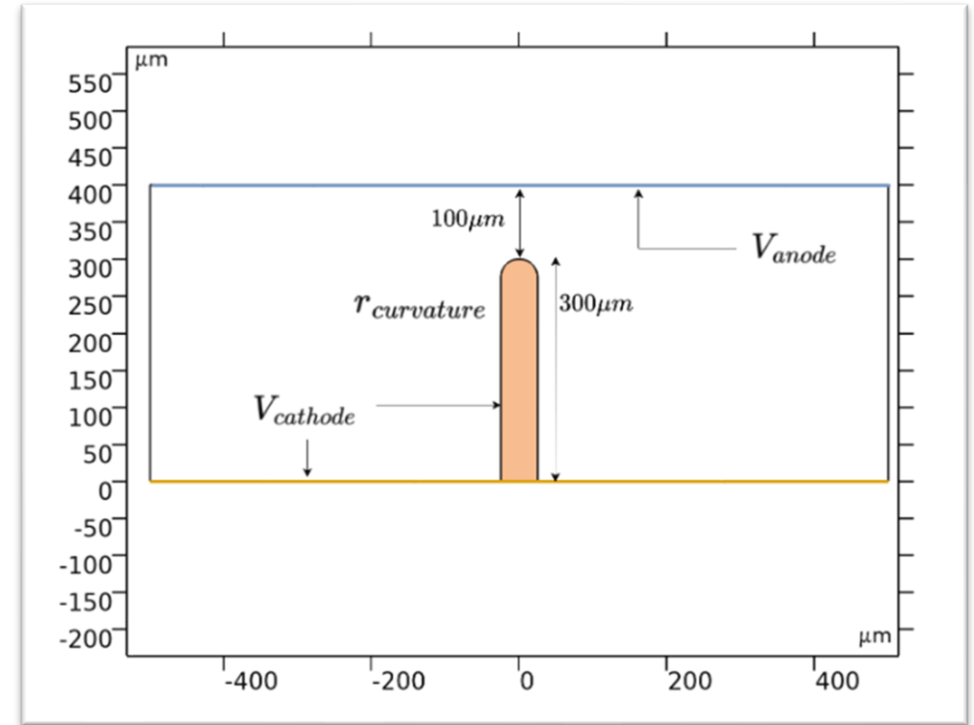
# Simulation of secondary scintillation in liquid

## Study of the optimal shape

- Baseline design: pillar with counter electrode at 100 $\mu\text{m}$
- Vary geometry and compare photon/electron yield

## Simulation procedure

1. E-field simulation (COMSOL)
2. Electron tracking (PyCOMES [1])
3. Emission simulation (Param. From [2])

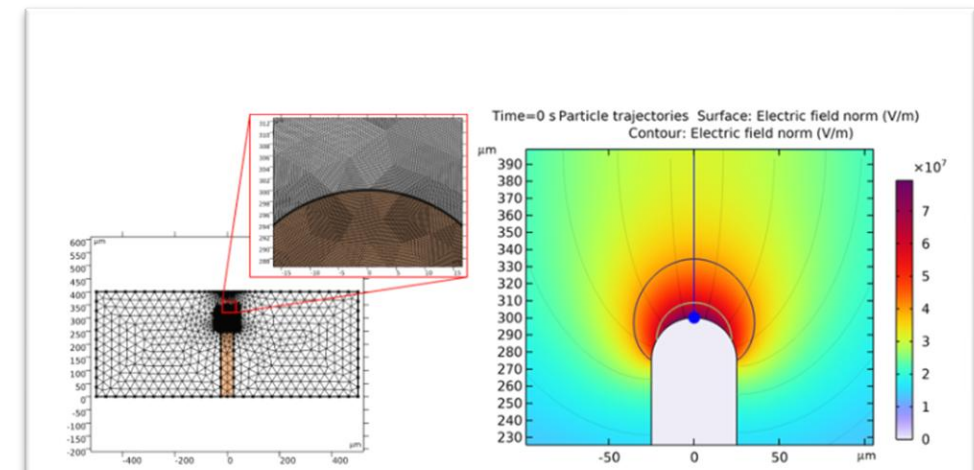


$$\Delta N_e = N_e \theta_0 \exp\left(-\frac{\theta_1}{E(\vec{x}, V_A, d_w) - \theta_2}\right) \Delta \vec{x},$$

$$\Delta N_\gamma = N_e \theta_3 (E(\vec{x}, V_A, d_w) - \theta_4) \Delta \vec{x},$$

$$\theta_2 = 586 \text{ [kV/cm]}$$

$$\theta_4 = 399 \text{ [kV/cm]}$$



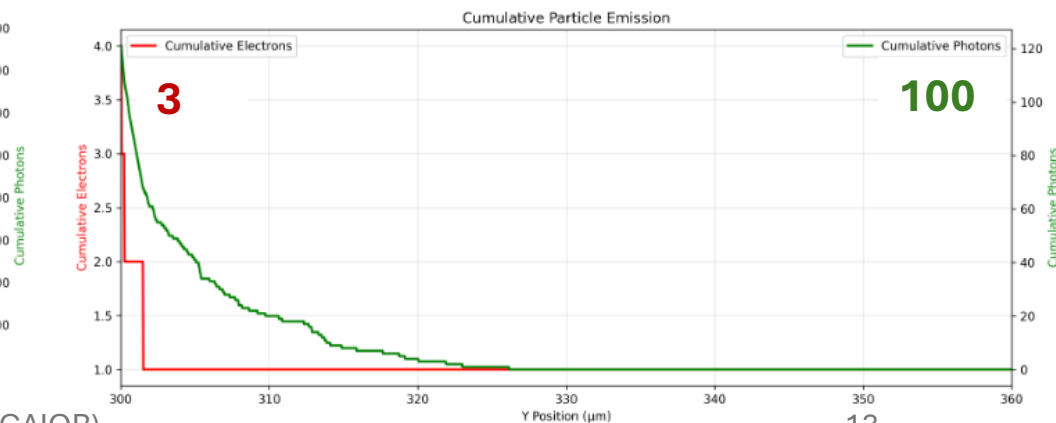
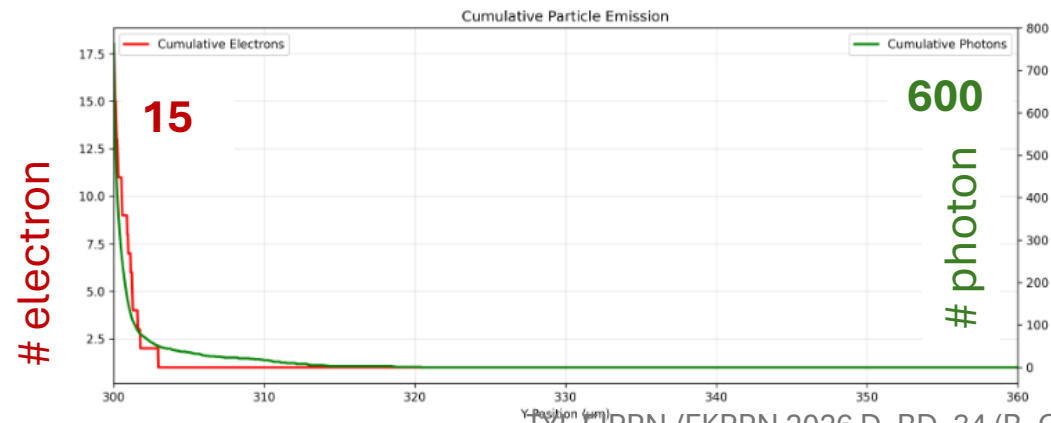
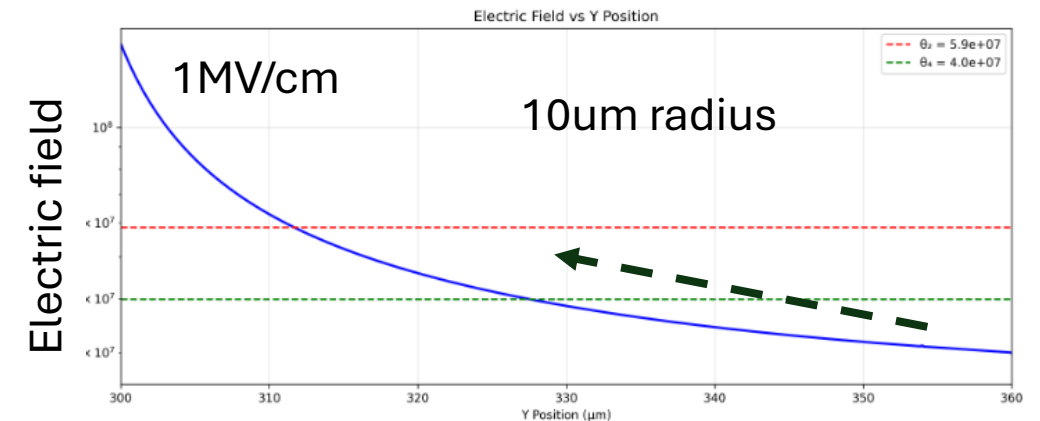
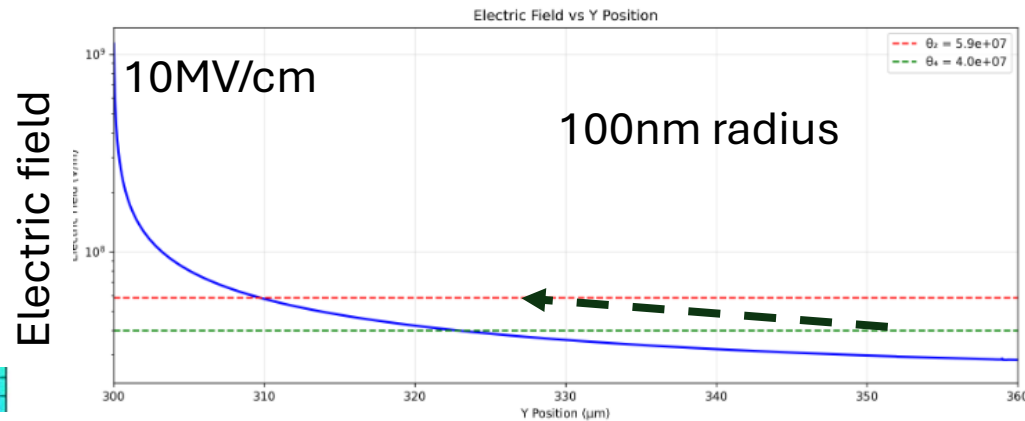
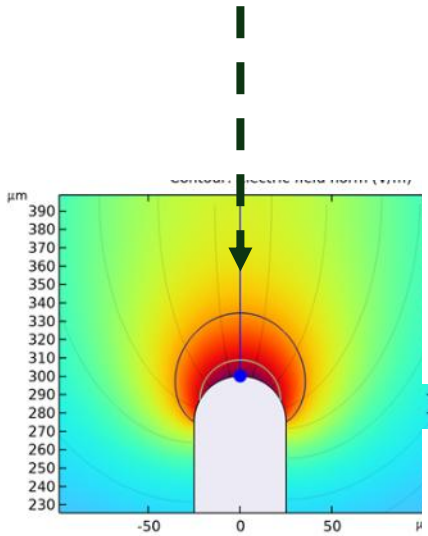
[1] <https://github.com/ftoschi/PyCOMES>

[2] arXiv:1408.6206v3 / E Aprile et al 2014 JINST 9 P11012

# Simulation of secondary scintillation

## Follow one electron moving toward the tip apex

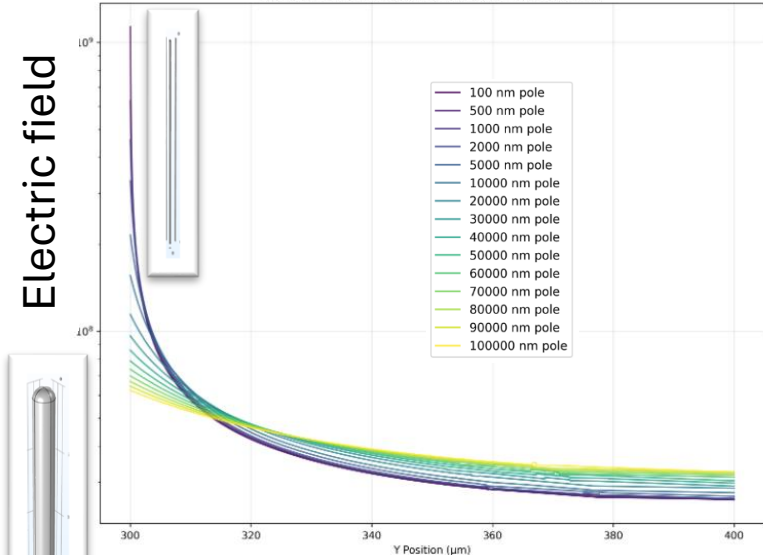
- Photon emission starts from the green line
- Electron emission starts from the red line
- Goal is ~2-3 electron and >100 photons



# Shape optimization

## Different radius

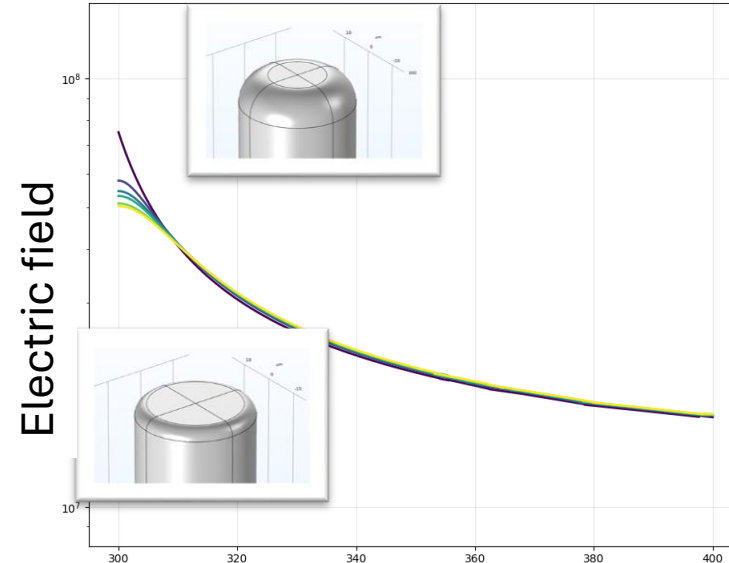
Electric Field vs Y Position for Different Pole Diameters



Position [ $\mu\text{m}$ ] (tip at 300 $\mu\text{m}$ )

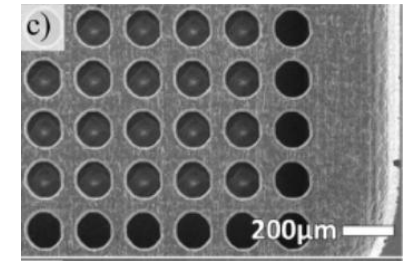
## Different fillet

Electric Field vs Y Position  
Pole Fillet Parameter Study



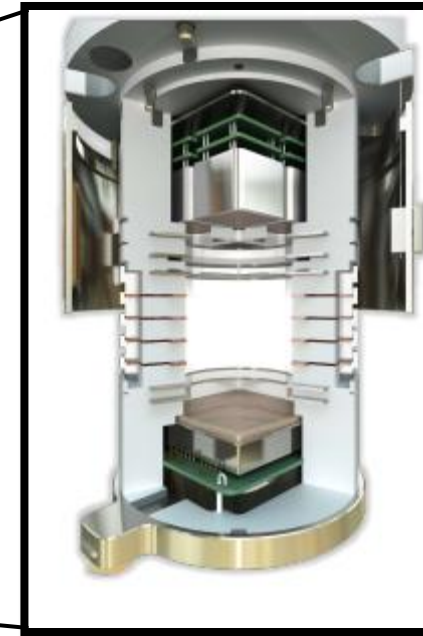
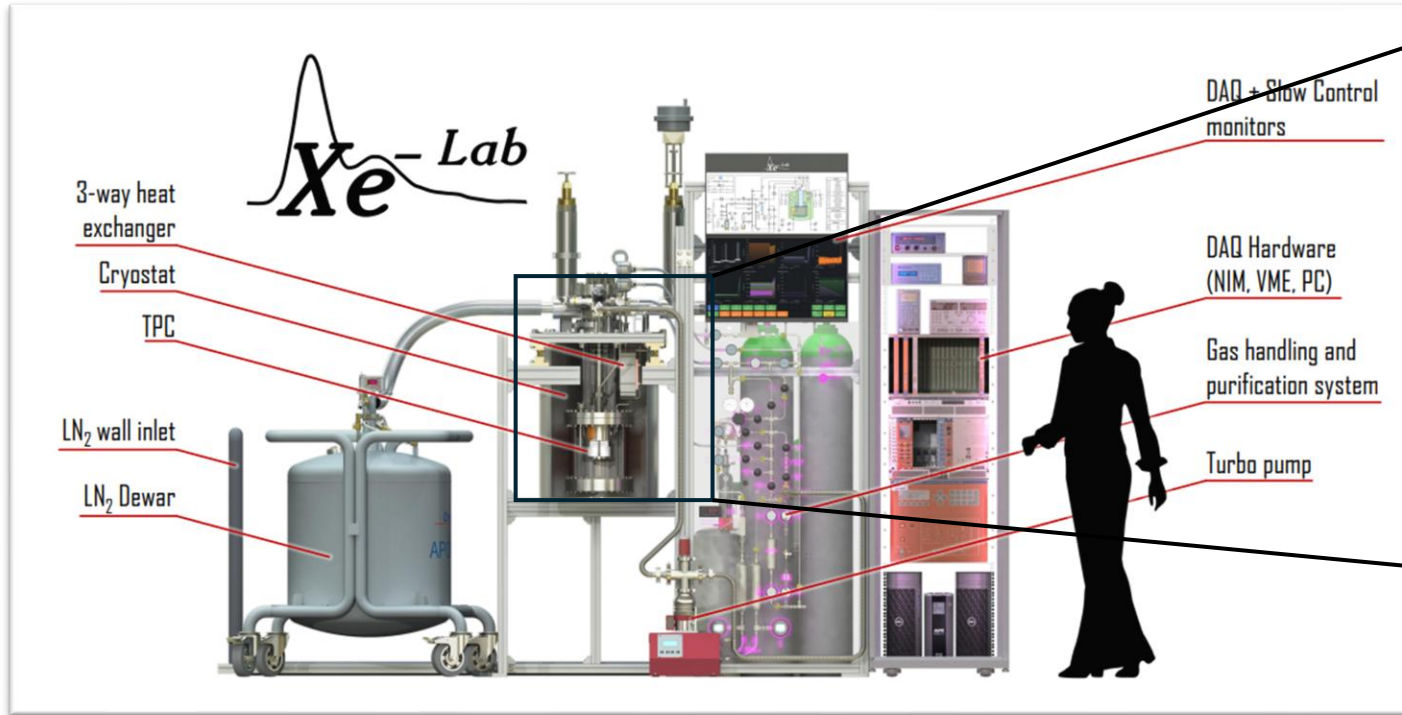
Position [ $\mu\text{m}$ ] (tip at 300 $\mu\text{m}$ )

## Grid position and shape

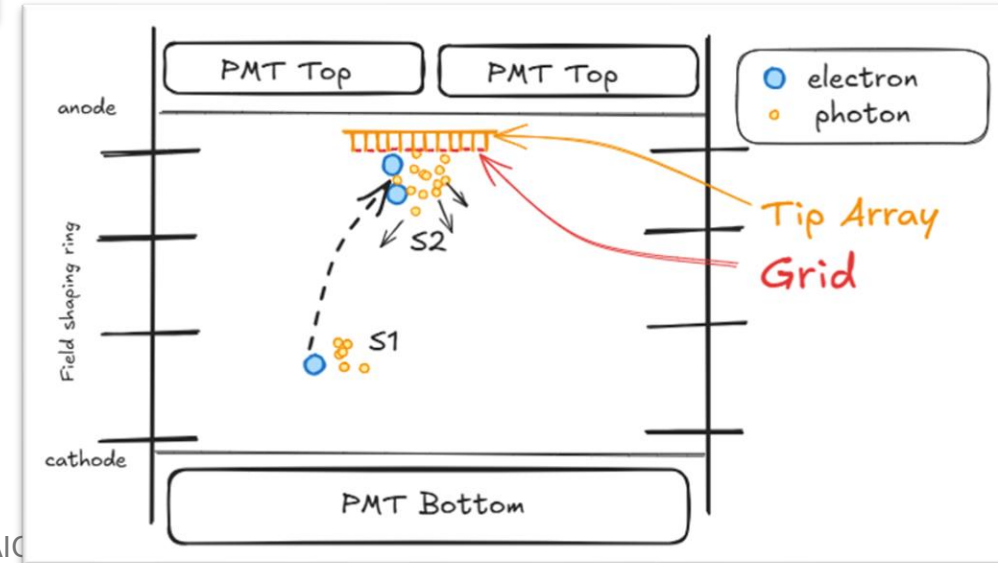


- **Optimisation:** Take advantage of the tip effect without getting too large field
- **Results:** 30 $\mu\text{m}$  diameter with aspect ratio of 10 (300 $\mu\text{m}$  high) and a flat top is a good candidate
- Final optimization needs to **account for a grid**

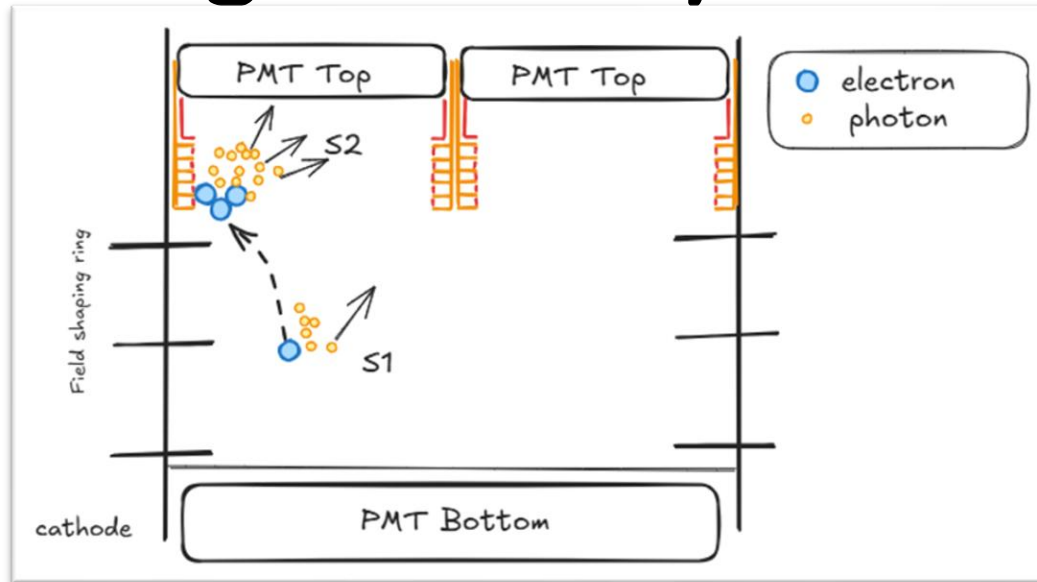
# Proof of concept design



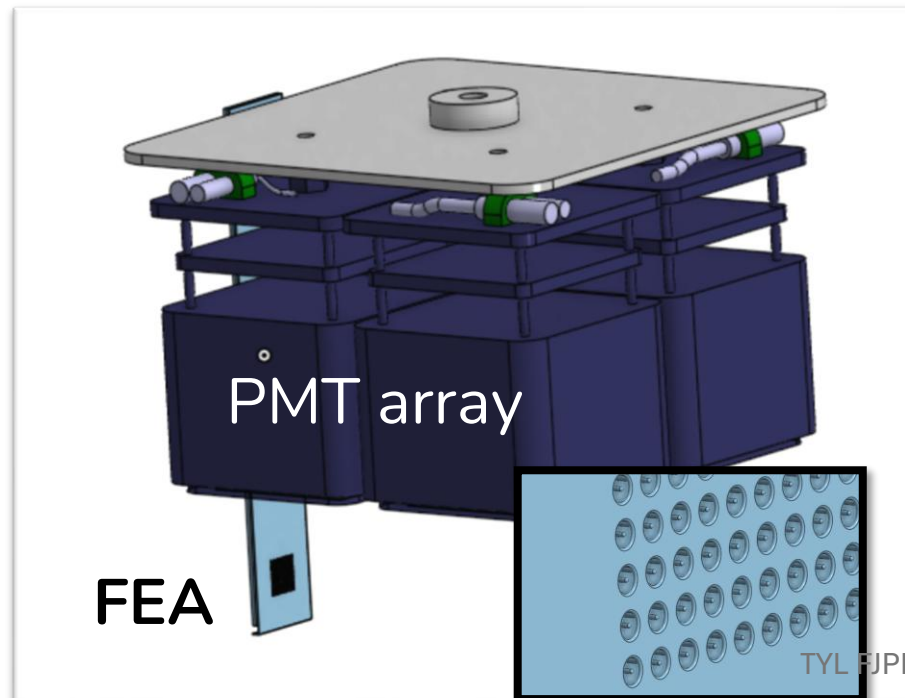
- Xelab @ LPNHE is a Liquid / Gaz Xenon cryogenic platform for electrode development
- Require minimal adaptation: Gate + Anode → FEA + Anode
- Demonstrate the concept
- Photon yield measurement system



# New geometry idea ...

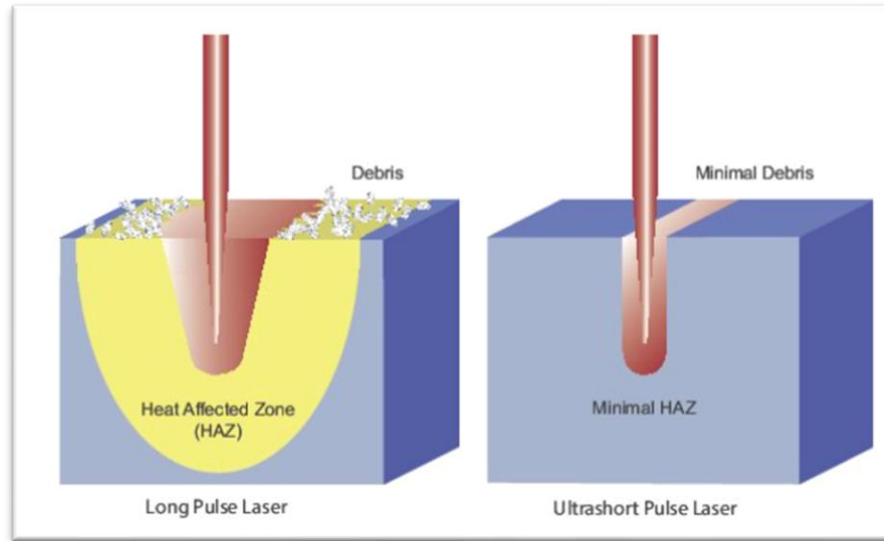


- Give up the planar electrode
- “Individual” amplifier: 1 or few per PMT
- Several advantages
  - Larger transparency: placed in the dead space between PMT
  - Individual device:
    - Easier fabrication
    - Pre calibration
    - Easier replacement
  - Shape optimization
- reasonable material budget (can be done in “radio clean” material like Copper, silicon)



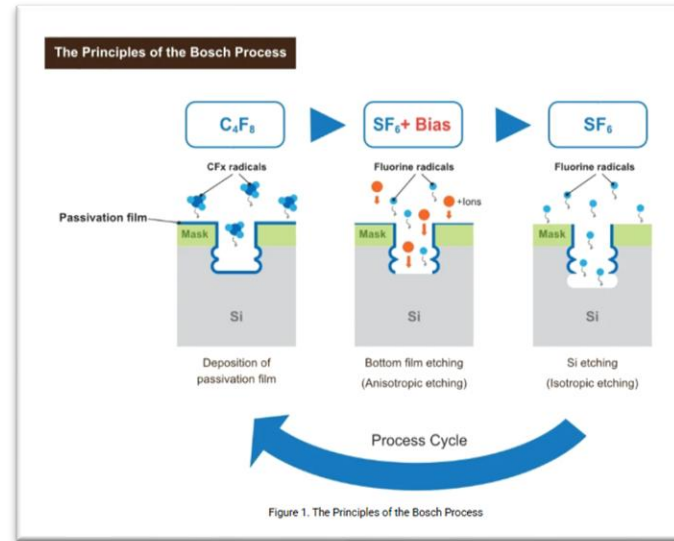
# Fabrication options

## Laser micromachining



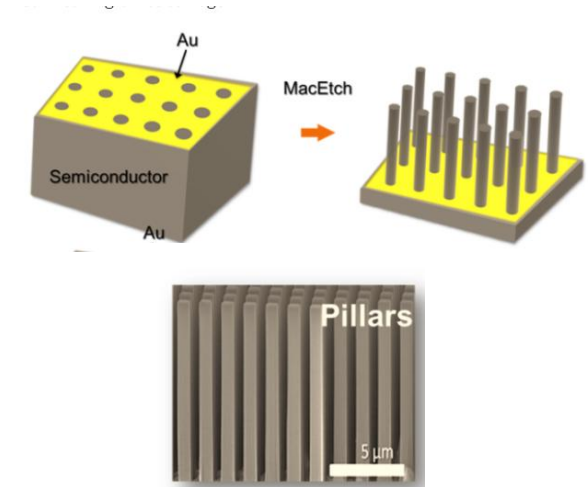
<https://www.forter.com.tw/zh-tw/a4-10998-12264/Laser-Micromachining.html>

## Deep Reactive Ion Etching



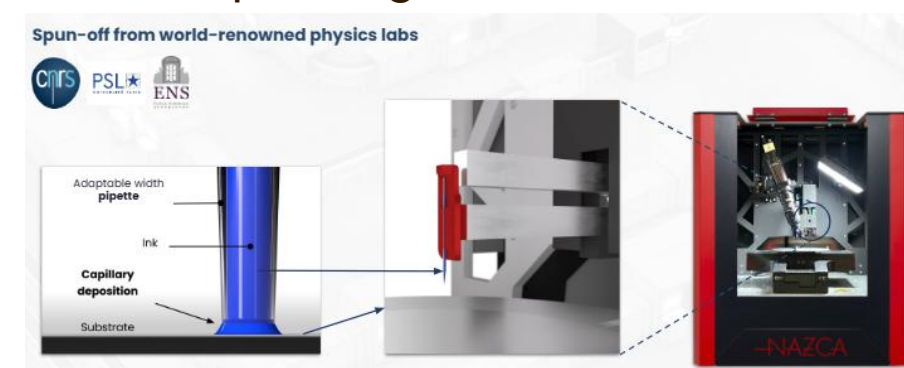
<https://www.samcointl.com/news-events/tutorials/what-is-the-bosch-process/>

## Metal-assisted Chemical Etching



<https://sites.utexas.edu/xiulingli/metal-assisted-chemical-etching-macetch/>

## 3D microprinting



<https://humink.com/what-is-microprinting/>

- Can be fabricated with semiconductor fab. technique
- Need a smooth surface state
- Prototyping friendly
- Maybe other options at HPK ?

# Conclusion

- Solid collaboration between France and Japanese team (now eased by R.G. moving to Japan)
- Some (human and experimental) resources exist  
→ Help for staff exchange would greatly help

## Next steps:

- Conclude about the positive charge emission and design a test with Radon
- Explore fabrication method for secondary scintillation
- Test device in Xelab (LPNHE) or other LXe facility